

March 2001 Revised June 2003

FIN1028

3.3V LVDS 2-Bit High Speed Differential Receiver

General Description

This dual receiver is designed for high speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The receiver translates LVDS levels, with a typical differential input threshold of 100 mV, to LVTTL signal levels. LVDS provides low EMI at ultra low power dissipation even at high frequencies. This device is ideal for high speed transfer of clock and data.

The FIN1028 can be paired with its companion driver, the FIN1027, or any other LVDS driver.

Features

- Greater than 400Mbs data rate
- 3.3V power supply operation
- 0.4ns maximum differential pulse skew
- 2.5ns maximum propagation delay
- Low power dissipation
- Power-Off protection
- Fail safe protection for open-circuit, shorted and terminated conditions
- Meets or exceeds the TIA/EIA-644 LVDS standard
- Flow-through pinout simplifies PCB layout
- 8-Lead SOIC and 8-terminal MLP packages save space

Ordering Code:

Order Number	Package Number	Package Description
FIN1028M (Note 1)	M08A	8-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
FIN1028MPX (Preliminary)	MLP08C	8-Terminal Molded Leadless Package (MLP) Dual, JEDEC MO-229, 2mm Square ITAPE and REEL1

Note 1: Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Pin Descriptions

Pin Name	Description
R _{OUT1} , R _{OUT2}	LVTTL Data Outputs
R _{IN1+} , R _{IN2+}	Non-inverting LVDS Inputs
R _{IN1} -, R _{IN2} -	Inverting LVDS Inputs
V _{CC}	Power Supply
GND	Ground

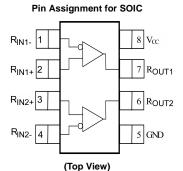
Function Table

Input	Outputs			
R _{IN+}	R _{IN+}	R _{OUT}		
L	Н	L		
Н	L	Н		
Fail Safe	Condition	Н		

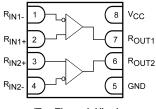
H = HIGH Logic Level L = LOW Logic Level

Fail Safe = Open, Shorted, Terminated

Connection Diagrams



Terminal Assignments for MLP



Absolute Maximum Ratings(Note 2)

DC Output Current (I_O) 16 mA Storage Temperature Range (T_{STG}) -65°C to +150°C

Max Junction Temperature (T_J)

 $\begin{tabular}{lll} Lead Temperature (T_L) & & & & & & \\ & (Soldering, 10 seconds) & & & & & \\ ESD (Human Body Model) & & & & \\ & & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & \\ & & & \\$

ESD (Machine Model)

Recommended Operating Conditions

 $\label{eq:Supply Voltage VCC} \mbox{Supply Voltage (V$_{CC})} \qquad \qquad 3.0 \mbox{V to } 3.6 \mbox{V} \\ \mbox{Input Voltage (V$_{IN})} \qquad \qquad 0 \mbox{ to } \mbox{V}_{CC} \\ \mbox{}$

Magnitude of Differential Voltage

($|V_{ID}|$) 100 mV to V_{CC}

Common-mode Input Voltage

(V_{IC}) 0.05V to 2.35V

Operating Temperature (T_A) -40° C to $+85^{\circ}$ C

Note 2: The "Absolute Maximum Ratings": are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specification.

DC Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 3)	Max	Units
V _{TH}	Differential Input Threshold HIGH	See Figure 1 and Table 1			100	mV
V_{TL}	Differential Input Threshold LOW	See Figure 1 and Table 1	-100			mV
I _{IN}	Input Current	V _{IN} = 0V or V _{CC}			±20	μΑ
I _{I(OFF)}	Power-OFF Input Current	$V_{CC} = 0V, V_{IN} = 0V \text{ or } 3.6V$			±20	μΑ
V _{OH}	Output HIGH Voltage	$I_{OH} = -100 \mu A$	V _{CC} -0.2			V
		$I_{OH} = -8 \text{ mA}$	2.4			v
V _{OL}	Output LOW Voltage	I _{OH} = 100 μA			0.2	V
		I _{OL} = 8 mA			0.5	v
V _{IK}	Input Clamp Voltage	I _{IK} = -18 mA	-1.5			V
Icc	Power Supply Current	$(R_{IN+} = 1V \text{ and } R_{IN-} = 1.4V) \text{ or }$			9	mA
		$(R_{IN+} = 1.4V \text{ and } R_{IN-} = 1V)$			9	IIIA
C _{IN}	Input Capacitance			4		pF
C _{OUT}	Output Capacitance			6		pF

150°C

≥ 300V

Note 3: All typical values are at $T_A = 25$ °C and with $V_{CC} = 3.3$ V.

AC Electrical Characteristics

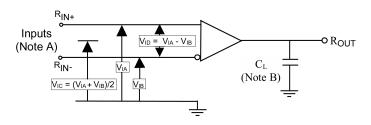
Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 4)	Max	Units
t _{PLH}	Differential Propagation Delay		0.9		2.5	ns
	LOW-to-HIGH					
t _{PHL}	Differential Propagation Delay		0.9		2.5	ns
	HIGH-to-LOW		0.3		2.5	113
t _{TLH}	Output Rise Time (20% to 80%)	$ V_{ID} = 400 \text{ mV}, C_L = 10 \text{ pF},$		0.5		ns
t _{THL}	Output Fall Time (80% to 20%)	See Figure 1 and Figure 2		0.5		ns
t _{SK(P)}	Pulse Skew t _{PLH} - t _{PHL}				0.4	ns
t _{SK(LH)} ,	Channel-to-Channel Skew				0.3	ns
t _{SK(HL)}	(Note 5)				0.3	115
t _{SK(PP)}	Part-to-Part Skew (Note 6)				1.0	ns

Note 4: All typical values are at $T_A = 25^{\circ}C$ and with $V_{CC} = 3.3V$.

Note 5: $t_{SK(LH)}$, $t_{SK(HL)}$ is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same direction.

Note 6: t_{SK(PP)} is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.



Note A: All input pulses have frequency = 10 MHz, t_R or t_F = 1 ns

Note B: \mathbf{C}_{L} includes all probe and fixture capacitances

FIGURE 1. Differential Driver Propagation Delay and Transition Time Test Circuit

TABLE 1. Receiver Minimum and Maximum Input Threshold Test Voltages

Applied V	oltages (V)	Resulting Differential Input Voltage (mV)	Resulting Common Mode Input Voltage (V)		
V _{IA}	V _{IB}	V _{ID}	V _{IC}		
1.25	1.15	100	1.2		
1.15	1.25	-100	1.2		
2.4	2.3	100	2.35		
2.3	2.4	-100	2.35		
0.1	0	100	0.05		
0	0.1	-100	0.05		
1.5	0.9	600	1.2		
0.9	1.5	-600	1.2		
2.4	1.8	600	2.1		
1.8	2.4	-600	2.1		
0.6	0	600	0.3		
0	0.6	-600	0.3		

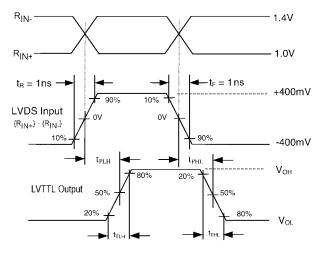
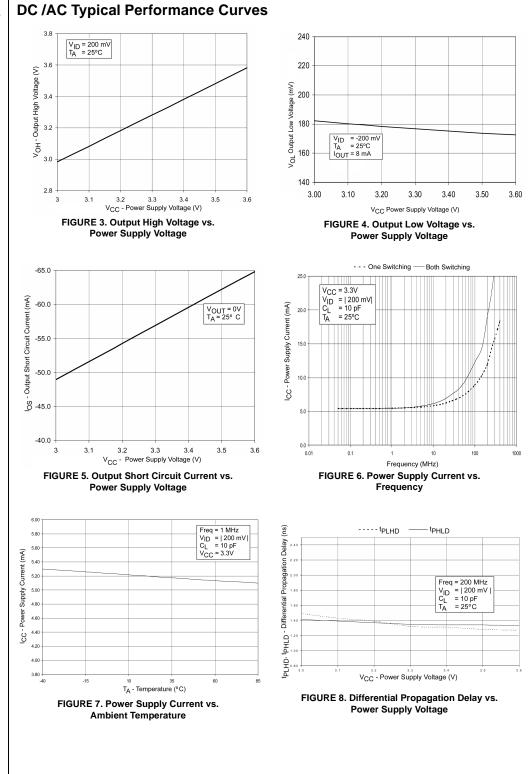
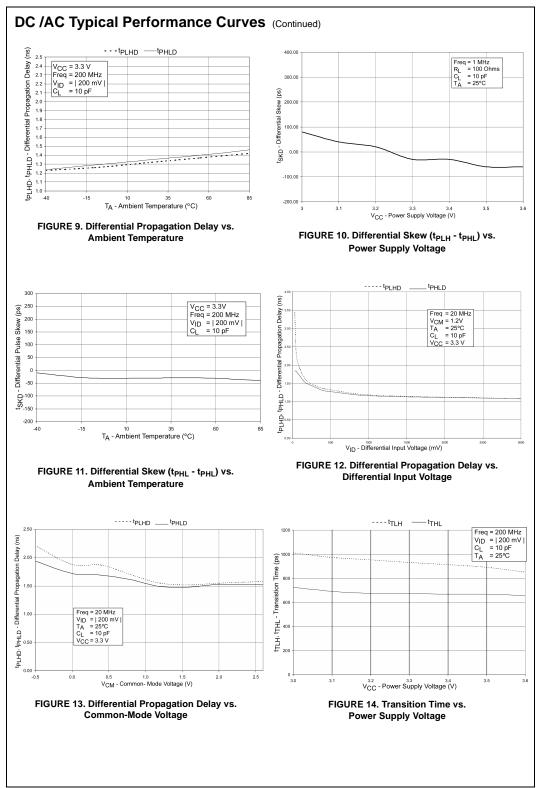
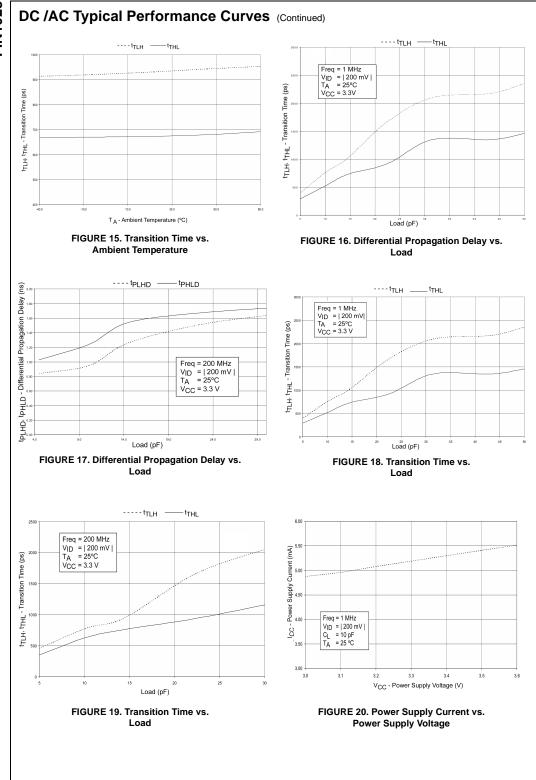


FIGURE 2. AC Waveforms





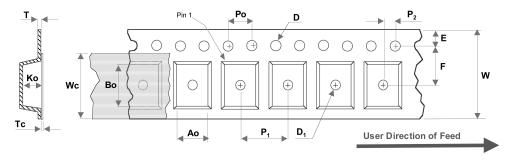


Tape and Reel Specification

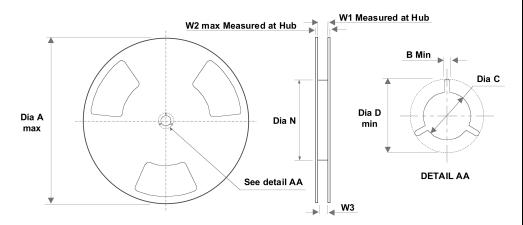
TAPE FORMAT for MLP

Package	Ao	Во	D	D ₁	E	F	Ko	P ₁	Po	P ₂	Т	T _C	W	Wc
rackage	±0.10	±0.10	±0.05	Min	±0.1	±0.1	±0.1	TYP	TYP	±0/05	TYP	±0.005	±0.3	TYP
2 x 2	2.30	2.30	1.55	1.0	1.75	3.5	1.0	8.0	4.0	2.0	0.3	0.06	8.0	5.3

MLP Embossed Tape Dimensions (Dimensions are in millimeters)

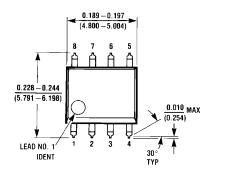


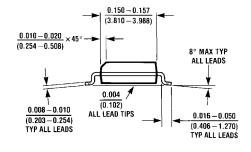
REEL DIMENSIONS (millimeters)

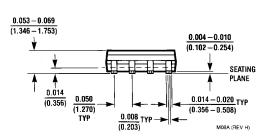


			Min	Min	+2/-0	Max	(LSL - USL)
8 mm 33	30 1.5	13	20.2	178	8.4	14.4	7.9 ~ 10.4

Physical Dimensions inches (millimeters) unless otherwise noted

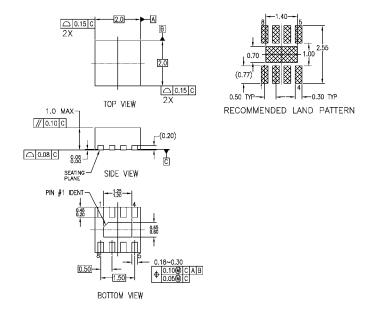






8-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M08A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-229, VARIATION VCCD-3, DATED 11/2001
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP08CrevB

8-Terminal Molded Leadless Package (MLP) Dual, JEDEC MO-229, 2mm Square
Package Number MLP08C
(Preliminary)

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